



N-Channel 200-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A)		
200	0.130 at V _{GS} = 10 V	4.1		
	0.142 at V _{GS} = 6.0 V	3.9		

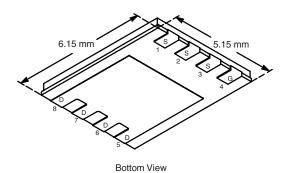
FEATURES

- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET[®] Power MOSFETs
- New Low Thermal Resistance PowerPAK[®]
 Package with Low 1.07 mm Profile
- · PWM Optimized For Fast Switching



FREE

PowerPAK SO-8

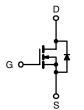


Ordering Information: Si7462DP-T1-E3 (Lead (Pb)-free)

Si7462DP-T1-GE3 (Lead (Pb)-free and Halogen-free)

APPLICATIONS

· Primary Side Switch



N-Channel MOSFET

Parameter		Symbol	10 s	Steady State	Unit
Drain-Source Voltage		V_{DS}	200		V
Gate-Source Voltage		V_{GS}	± 20		V
Continuous Drain Current /T 150 °C\a	T _A = 25 °C	I _D	4.1	2.6	А
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 85 °C		3.0	1.9	
Pulsed Drain Current		I _{DM}	12		A
Avalanche Current	L = 0.1 mH	I _{AS}	6 1.8		
Single Avalanche Energy (Duty Cycle ≤ 1 %)	L = 0.1 IIII1	E _{AS}			mJ
Continuous Source Current (Diode Conduction) ^a		I _S	4.0	1.6	
Manipular Device Discipational	T _A = 25 °C	P _D	4.8	1.9	W
Maximum Power Dissipation ^a	T _A = 85 °C		2.6	1.0	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C
Soldering Recommendations (Peak Temperature) ^{b,c}			260		

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^a	t ≤ 10 s	R _{thJA}	21	26	°C/W
Maximum Junction-to-Ambient	Steady State		55	65	
Maximum Junction-to-Case (Drain)	Steady State	R_{thJC}	1.7	2.1	

Notes:

- a. Surface Mounted on 1" x 1" FR4 board.
- b. See Solder Profile (www.vishay.com/ppg?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

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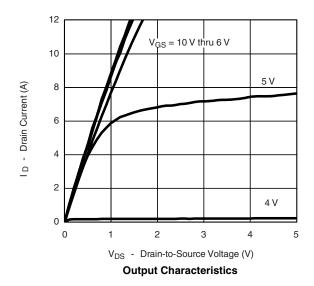
Parameter	Symbol	Test Condition	Min.	Тур.	Max.	Unit	
Static			•	•			
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2		4	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 200 V, V _{GS} = 0 V	, do		1	μΑ	
		$V_{DS} = 200 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 85 ^{\circ}\text{C}$			20		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	12			Α	
Drain-Source On-State Resistance ^a	В	V _{GS} = 10 V, I _D = 4.1 A	A		0.130	0	
	R _{DS(on)}	$V_{GS} = 6.0 \text{ V}, I_D = 3.9 \text{ A}$		0.120	0.142	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 4.1 A		13		S	
Diode Forward Voltage ^a	V_{SD}	I _S = 4 A, V _{GS} = 0 V		0.8	1.2	٧	
Dynamic ^b			•	•			
Total Gate Charge	Q_g			20	30	nC	
Gate-Source Charge	Q _{gs}	$V_{DS} = 100 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 4.1 \text{ A}$		4.5			
Gate-Drain Charge	Q_{gd}			6.5		1	
Gate Resistance	R_g			2		Ω	
Turn-On Delay Time	t _{d(on)}			15	25		
Rise Time	t _r			15	25		
Turn-Off Delay Time	t _{d(off)}	$t_{d(off)}$ $I_D \cong 1 \text{ A, } V_{GEN} = 10 \text{ V, } R_g = 6 \Omega$		40	60	ns	
Fall Time	t _f			20	30		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 4 A, dl/dt = 100 A/μs		70	110		

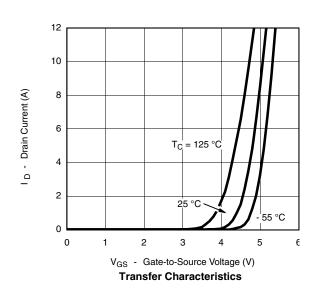
Notes:

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



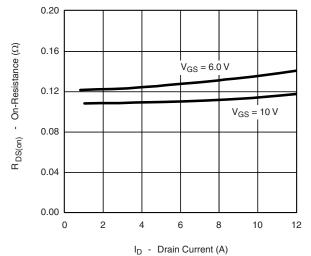




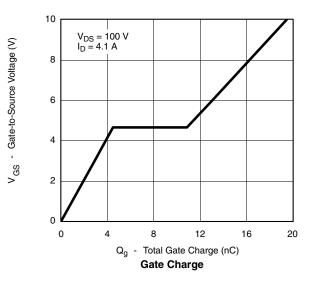


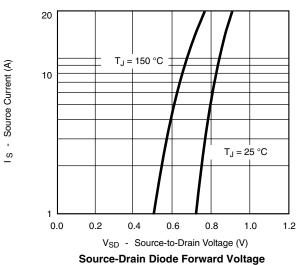


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On-Resistance vs. Drain Current

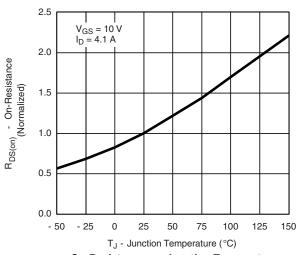




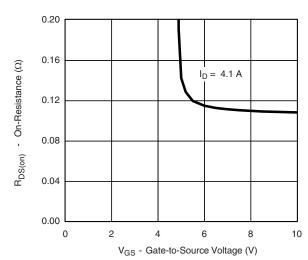
1600 1400 C - Capacitance (pF) 1200 1000 800 600 400 200 C_{oss} 0 10 20 30 40 60 70 80

V_{DS} - Drain-to-Source Voltage (V)

Capacitance



On-Resistance vs. Junction Temperature

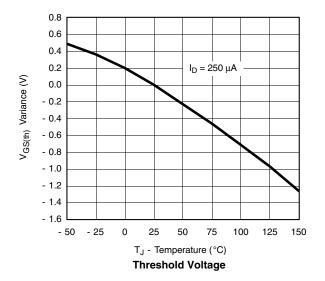


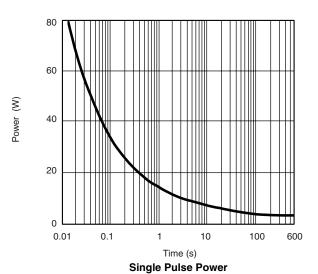
On-Resistance vs. Gate-to-Source Voltage

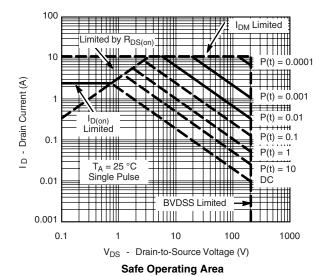
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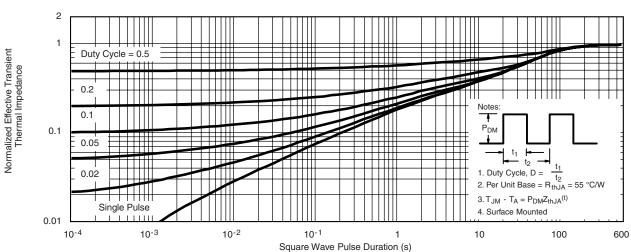
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





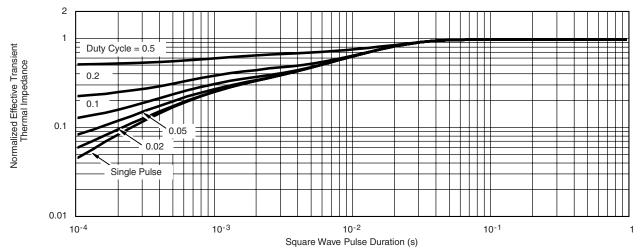




Normalized Thermal Transient Impedance, Junction-to-Ambient



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Case

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Document Number: 91000 www.vishay.com
Revision: 11-Mar-11 1